



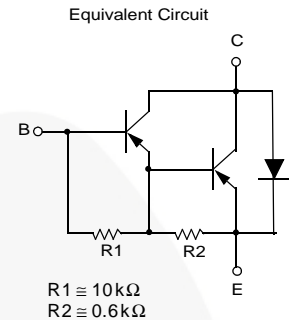
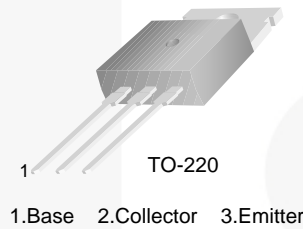
December 2014

TIP105 / TIP107

PNP Epitaxial Silicon Darlington Transistor

Features

- Monolithic Construction with Built-in Base-Emitter Shunt Resistors
- High DC Current Gain:
 $h_{FE} = 1000$ @ $V_{CE} = -4$ V, $I_C = -3$ A (Minimum)
- Collector-Emitter Sustaining Voltage
- Low Collector-Emitter Saturation Voltage
- Industrial Use
- Complementary to TIP102



Ordering Information

Part Number	Top Mark	Package	Packing Method
TIP105	TIP105	TO-220 3L (Single Gauge)	Bulk
TIP105TU	TIP105	TO-220 3L (Single Gauge)	Rail
TIP107	TIP107	TO-220 3L (Single Gauge)	Bulk
TIP107TU	TIP107	TO-220 3L (Single Gauge)	Rail

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage	TIP105	-60
		TIP107	-100
V_{CEO}	Collector-Emitter Voltage	TIP105	-60
		TIP107	-100
V_{EBO}	Emitter-Base Voltage	-5	V
I_C	Collector Current (DC)	-8	A
I_{CP}	Collector Current (Pulse)	-15	A
I_B	Base Current (DC)	-1	A
T_J	Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-65 to 150	$^\circ\text{C}$

TIP105 / TIP107 — PNP Epitaxial Silicon Darlington Transistor

Thermal Characteristics

Values are at $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Unit
P_C	Collector Dissipation ($T_A = 25^\circ\text{C}$)	2	W
	Collector Dissipation ($T_C = 25^\circ\text{C}$)	80	

Electrical Characteristics⁽¹⁾

Values are at $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit
$V_{CE(sus)}$	Collector-Emitter Sustaining Voltage	TIP105	$I_C = -30\text{ mA}, I_B = 0$	-60	V
		TIP107		-100	
I_{CEO}	Collector Cut-Off Current	TIP105	$V_{CE} = -30\text{ V}, I_B = 0$	-50	μA
		TIP107	$V_{CE} = -50\text{ V}, I_B = 0$	-50	
I_{CBO}	Collector Cut-Off Current	TIP105	$V_{CB} = -60\text{ V}, I_E = 0$	-50	μA
		TIP107	$V_{CB} = -100\text{ V}, I_E = 0$	-50	
I_{EBO}	Emitter Cut-Off Current	$V_{EB} = -5\text{ V}, I_C = 0$		-2	mA
h_{FE}	DC Current Gain		$V_{CE} = -4\text{ V}, I_C = -3\text{ A}$	1000	20000
			$V_{CE} = -4\text{ V}, I_C = -8\text{ A}$	200	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		$I_C = -3\text{ A}, I_B = -6\text{ mA}$	-2.0	V
			$I_C = -8\text{ A}, I_B = -80\text{ mA}$	-2.5	
$V_{BE(on)}$	Base-Emitter On Voltage	$V_{CE} = -4\text{ V}, I_C = -8\text{ A}$		-2.8	V
C_{ob}	Output Capacitance	$V_{CB} = -10\text{ V}, I_E = 0,$ $f = 0.1\text{ MHz}$		300	pF

Note:

1. Pulse test: $p_w \leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.

Typical Performance Characteristics

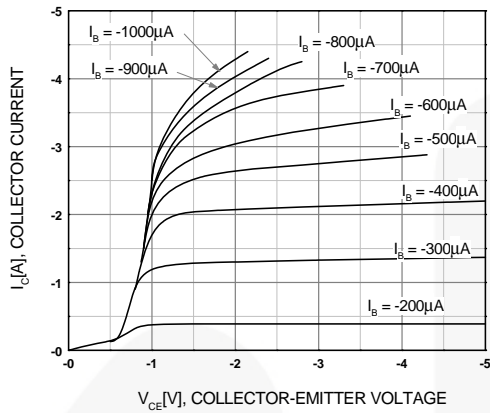


Figure 1. Static Characteristic

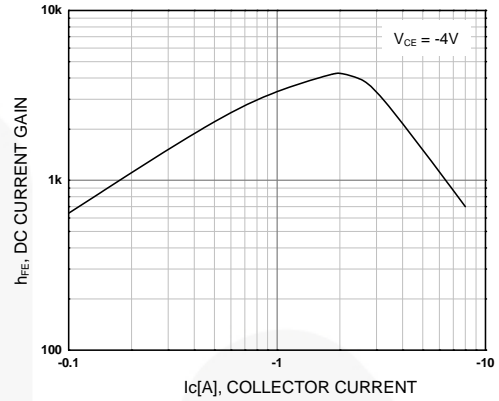


Figure 2. DC Current Gain

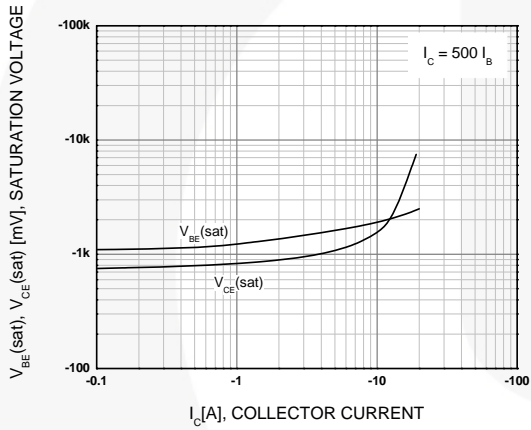


Figure 3. Collector-Emitter Saturation Voltage and Base-Emitter Saturation Voltage

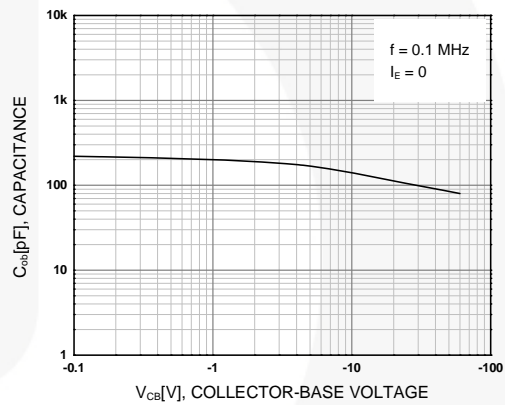


Figure 4. Collector Output Capacitance

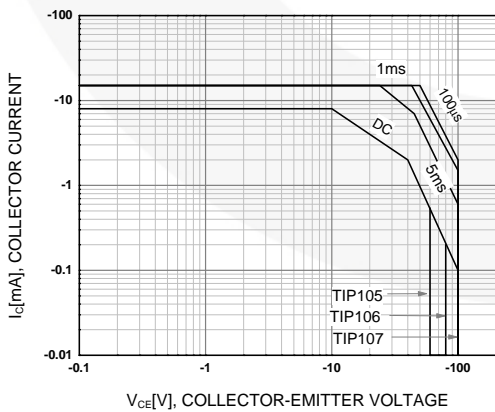


Figure 5. Safe Operating Area

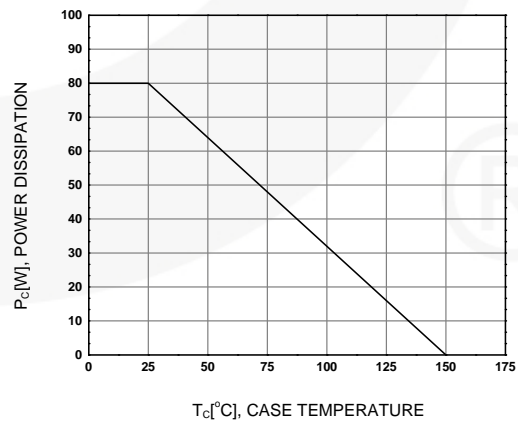


Figure 6. Power Derating

Physical Dimensions

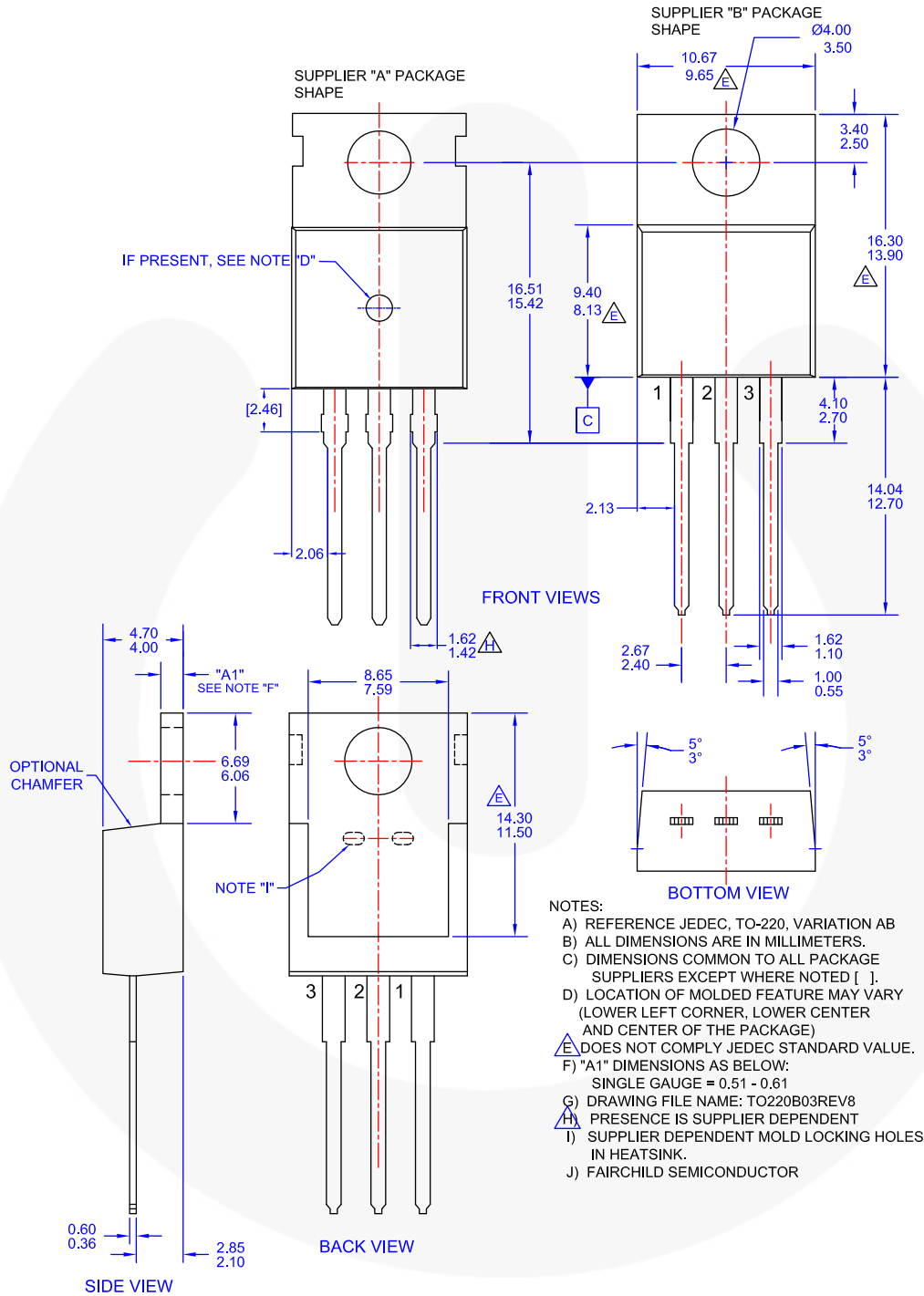


Figure 7. TO-220, MOLDED, 3LEAD, JEDEC VARIATION AB



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Rev. I72